



MARCH 20-22, 2019 SNIEC, SHANGHAI, CHINA

CONNECT + COLLABORATE + INNOVATE

Co-located with

FPDCHINA

KEY ATTENDING COMPANIES

- Advantest Corporation
- AMEC (Advanced Micro-Fabrication Equipment Inc.)
- China Electronics System Engineering No. 2 Construction Co., Ltd.
- CSMC Technologies Corporation
- Ferrotec
- Hangzhou Silan Integrated Circuit Co., Ltd.
- Hitech Semiconductor (Wuxi), Ltd.
- Huawei
- HYC
- Jiangsu Changjiang Electronics Technology Co., Ltd.
- Konfoong Materials International Co., Ltd.
- Marketech International Corp.
- NAURA Technology Group Co., Ltd.
- PNC Process Systems Co., Ltd.
- QL Electronics Co., Ltd.
- SCH Electronics (Shanghai) Co., Ltd
- Shanghai GenTech Co., Ltd.
- Shanghai Huahong Grace Semiconductor Manufacturing Corporation
- Shanghai Huali Microelectronics Corporation
- SK hynix Semiconductor (China), Ltd.
- SMC
- SMIC (Semiconductor Manufacturing International Corporation)
- Teradyne (Shanghai)
- Tongfu Microelectronics Co., Ltd.
- ZINGSEMI

2019 NUMBERS

REGISTRATION

Total Attendance	101,054
SEMICON/FPD China Visitors	35,711
SEMICON/FPD China Exhibitors	22,312
EP/Laser China Visitors	43,031

INTERNATIONAL ATTENDANCE

Total SEMICON/FPD China International Visitors

(percentage of international SEMICON/FPD China visitors)					
South Korea	30%	Hong Kong SAR	3%		
Taiwan Region	29%	Malaysia	3%		
Japan	17%	Germany	1%		
Singapore	5%	Russia	1%		

5%

EXHIBITOR INFORMATION

USA

Total SEMICON/FPD China Exhibiting Companies	1,186
Total Net Occupied Exhibit Area (sqm.)	36,594
Booths	4,066

5.267



VISITOR PROFILE

SEMICON China and FPD China attract a highly influential audience from every segment and sector of the global microelectronics industries, including semiconductors, LEDs, OLEDs, MEMS, flexible hybrid electronics, and other adjacent markets.

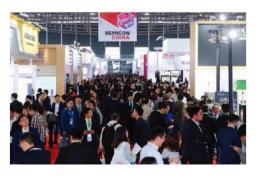
Co-located with



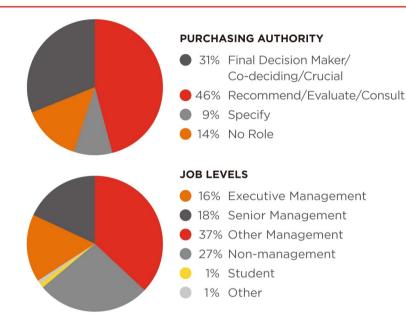


7700 of visitors are involved in purchasing decisions

> 48% of visitors represent engineering functions



INFLUENTIAL BUYERS



PRIMARY JOB FUNCTIONS

R&D

Danion

SEMICON China and FPD China attract multi-level buying teams, with broad representation across all levels, functions and industries.

Design	9%
Equipment Engineering	7%
Fabrication and Process Engineering	5%
Facilities/Engineering Support	3%
Packaging/Assembly	3%
Test	3%
Chemicals/Materials	2%
Industrial Engineering	1%
Quality Assurance/Failure Analysis/Reliability	1%
Software Engineering	1%
Marketing, Sales, Business Development	19%
Product Management	6%
Purchasing/Procurement/Office Management	6%
Executive Management/Board Member	4%
Financial/Industry Analyst/Investor Relations	3%
Manufacturing/Operations Management/Production	3%
Government/Public Policy	1%
Human Resources	1%
Integration/IT Support	1%
Logistics/Supply Chain Management	1%
Environment, Health and Safety (EHS)	<1%
Training/Education	<1%
Other	6%

13%

00/



AREAS OF INTEREST

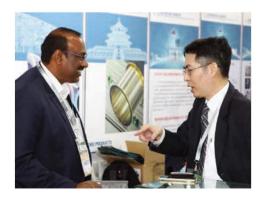
Co-located with



SEMICON China and FPD China visitors are interested in a broad range of industries, technologies, and products from across the supply chain, from design to final manufacturing.

INDUSTRIES SERVED

82%
14%
14%
12%
12%
11%
10%
10%
8%
7%
7%
6%
6%
6%
5%
5%
4%
4%
3%
2%
1%
1%
3%



AREAS OF INTEREST

MANUFACTURING TECHNOLOGIES

MANUFACTURING TECHNOLO	GIES		
Front-end Manufacturing	44%	System Integration/	15%
(IDM, foundry)		Product-level Manufacturing	
Packaging/Assembly	37%	System-level Manufacturing	14%
Test	35%	Board-level Manufacturing	8%
Design/EDA/IP	34%	Roll-to-Roll/Printing	8%
Material Engineering/ Materials Science	31%	Other	12%
Materials Science			
APPLICATION INTERESTS			
Smart Manufacturing	57%	Virtual Reality/Augmented	19%
Artificial Intelligence	35%	Reality (VR/AR)	,
Systems (AI)		Wearables	18%
Automotive Electronics/	28%	Medical Electronics/MedTech	14%
Smart Transportation		Cloud Computing/High-	9%
Internet of Things (IoT)	28%	performance Computing	
Consumer Electronics	21%	Green Manufacturing/EHS	9%
Mobile Technologies/	21%	Imaging	8%
Wireless/5G	010/	Other	11%
OLED	21%		
PRODUCT/SERVICE INTEREST	·s_		
DESIGN/MANUFACTURING SERVI			
Foundries	41%	Manufacturing Services	17%
Packaging and Test Services	32%	and Consulting	1770
(OSAT)	0_/0	Factory control/Process	15%
Design/EDA	29%	Software	
Fabless	24%	Engineering Services	13%
Electronic Manufacturing	17%	R&D/Technology Transfer	12%
Services (EMS)/System		Other	11%
Integration			
MANUFACTURING EQUIPMENT			
Front-end Processing	30%	Printing/Coating/Roll-to-Roll	12%
Assembly/Packaging	24%	Secondary Equipment	11%
Test	24%	and Services	
Factory Automation/Robotics	18%	Components/Sub-systems/	8%
Inspection and Measurement/	15%	Instrumentation	
Metrology		Abatement/Environmental	5%
Large-area/Thin Film	14%	Systems	110/
Parts	13%	Other	11%
MATERIALS			
Wafers/Substrates	39%	Cleaning	12%
Process Materials: Gases/	25%	Consumables	9%
Liquids/Solids/Chemicals	2570	Inks/Pastes/Printing Materials	8%
Packaging/Assembly	22%	Other	13%
071170			
OTHER Support Products/Cleanroom	19%	General Business Services/	11%
Representative Sales	12%	Consulting	1170
and Service	12/0	Standards	7%
		Other	11%



Co-located with



Sessions and Events



779

Grand Opening Keynote



337

SIIP China: SEMI Innovation and Investment Forum



393

SEMI Workforce CXO Talent Forum



468

Power & Compound Semiconductor International Forum



178

Advanced Manufacturing Forum



257

Advanced Packaging Forum - Heterogeneous Integration



161

Brave New World -MSIG Conference on AI+IoT



277

Memory Strategic Forum



788

Smart Manufacturing Forum



186

Smart Transportation Forum



190

Green High-Tech Facility Forum



182

2019 China Display Conference -Emerging Display Forum



588

New Technology Release Conference



830

China Semiconductor Technology International Conference